

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
Name		Execution Date
FABIO HIDEKI OKUYAMA		02/26/2007
ANDRE LUIS DO COUTO		02/26/2007
RECEIVING PARTY DATA		
Name:	Freescale Semicondutor, Inc.	
Street Address:	6501 William Cannon Drive West	
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PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	11682674	
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ATTORNEY DOCKET NUMBER:	FREESCALE.TS10056ZC	
NAME OF SUBMITTER:	Craig J. Yudell	
Total Attachments: 2 source=TS10056ZC_Assignment#page1.tif source=TS10056ZC_Assignment#page2.tif		

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**PATENT
ASSIGNMENT AND AGREEMENT**

For good and valuable consideration, the receipt of which is hereby acknowledged, we, **FABIO HIDEKI OKUYAMA**, of Campinas, Sao Paulo, Brazil, and **ANDRE LUIS DO COUTO** of Jaguariuna, Sao Paulo, Brazil have sold, assigned and transferred, and do hereby sell, assign and transfer, unto FREESCALE SEMICONDUCTOR, INC., a corporation of the State of Delaware, having its principal office in Austin, State of Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest in and to certain inventions relating to improvements in **TECHNIQUE FOR IMPROVING EFFICIENCY OF A LINEAR VOLTAGE REGULATOR** (Docket No. TS10056ZC), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

We hereby also sell, assign and transfer unto FREESCALE SEMICONDUCTOR, INC., the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof, and we further authorize FREESCALE SEMICONDUCTOR, INC. to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to FREESCALE SEMICONDUCTOR, INC., for the sole use and benefit of FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to FREESCALE SEMICONDUCTOR, INC.

We agree that, when requested, we will, without charge to FREESCALE SEMICONDUCTOR, INC., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for

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the inventions in any and all countries and for vesting title thereto in FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives or nominees.

We covenant with FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.


FABIO HIDEKI OKUYAMA


DATE: 02/26/2007


WITNESS FERNANDO CHAVEZ

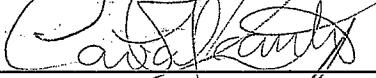
DATE: 02/26/2007


WITNESS RICARDO FITOR CASTÊL


DATE: 02/26/2007


ANDRE LUIS DO COUTO

DATE: 02/26/2007


WITNESS CARLOS JOSE LEITE CAVALCANTI

DATE: 02/27/2007


WITNESS FELIPE R. CLAYTON

DATE: 02/28/2007